# Harvatek Surface Mount CHIP LEDs Approval Sheet Model No.: HT-U169BP

Acknowledged by

Section Manager

**Production Engineering Dept.** 

Manager

**Production Engineering Dept.** 

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Tentative Product	*******	******	HDS-U169-K299	
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### Introduction

- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by HARVATEK for any infringements of intellectual property or other rights of the third parties which may result from it use.
- Harvatek is continually effort to improve the quality of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing HARVATEK products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such HARVATEK products cause loss of human life, bodily injury or damage to property.
- The HARVATEK products listed in this document are intended for usage in general electronics (computer, personal equipment, office equipment, industrial robotics, domestic, etc...) These products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury.
- In developing your designs, please ensure that HARVATEK products are used within specified operating ranges as set forth in the most recent HARVATEK products specifications.
- Also, please keep in mind the precautions listed in this document.

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## **Product Specification**

	Specification	Material	Quantity
lv	800-1610 mcd		
	@20mA/ Ta= 25 <sup>o</sup> C		
	Tolerance: ± 10%		
Chromaticity	Refer to page 8		
Coordinates	@20mA/ Ta= 25 <sup>o</sup> C Tolerance: <u>+</u> 0.01		
Vf	2.7-3.7V (0.2V/bin)		
	@20mA Ta= 25 <sup>o</sup> C		
	Tolerance: ± 0.05V		
Ir	< 100 μA @ V <sub>R</sub> = 5 V		
Resin	Yellow	Epoxy resin	
Carrier tape	According to EIA 481-1A specs	Conductive black tape	2000pcs per reel
Reel	According to EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel one bag
Carton	HT standard	Paper	Non-specified
			1

#### Others:

Every mid-box will be loaded 5 reels. These 5 reels can be different in lot, lv, lambda, or Vf. Every reel will have an independent label to identify its specification and the mid-box there will have a corresponding label post on it.

### ATTENTION: Electric static Discharge (ESD) protection



The symbol shown on the page herein to introduce 'Electro-Optical Characteristics'. ESD protection for GaP and AlGaAs based chips is still necessary even though they are safe in low static-electric discharge. Parts built with AlInGaP,

GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD protection has to considered and taken in the initial design stage.

If manual work/process is needed, please ensure the device is well protected from ESD during all the process.

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# **Product Specification**

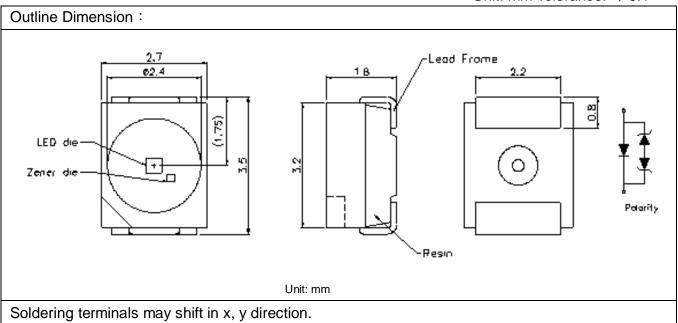
## **Electro-Optical Characteristics**

(I<sub>F</sub> @ 20mA, T<sub>a</sub> 25 °C)

Product No. Lighting C	Lighting Color	Material	V <sub>F</sub> (V)		λ (nm)			I <sup>*</sup> <sub>V</sub> (mcd)	
	Lighting Color	ing Color Waterial	min	max	λь	λр	$\triangle \lambda$	min	max
HT-U169TW	White	InGaN	2.7	3.7	X=0.30 Y=0.31			800	1610

# Package Outline Dimension

Unit: mm Tolerance: +/-0.1



# **Absolute Maximum Ratings**

 $(T_a 25 °C)$ 

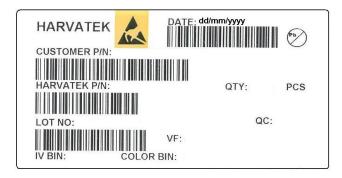
Series	P <sub>d</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> (mA)	Ir (μA) @ V <sub>R</sub> = 5 V	T <sub>OP</sub> (°C)	T <sub>ST</sub> (°C)
HT-U169TW	111	30	100**	<1µA	-30~+85	-40~+100

<sup>\*\*</sup> Condition for I<sub>FP</sub> is pulse of 1/10 duty and 0.1msec width.

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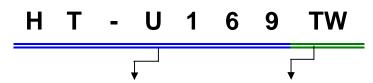


# Label Spec.



**■**Customer P/N: To Be Defined

■ Harvatek P/N



Series Name	Emitting Color	
HT-U169: 3.5x2.8x1.9mm	TW:	
11-0169: 3.3X2.6X1.9MM	White	

Lot No.

1 2 3 4 5 6 7 8 9 10 Ρ 1 2 2 3 0 Α D T

Code 1	Code 2	Code 3	Code 4, 5	Code 6, 7	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Lots	Resin Color	Packaging
Internal Tracing Code	1: 2001 2: 2002 3: 2003 4: 2004	1: Jan. 2: Feb.  9: Sep. A: Oct. B: Nov. C: Dec.	1~31/ (30)	01~99, A,B,C	D: Milky Whit	T: Taped Reel

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## ■ Bin Code.

# ■ Iv Bin:

Color	Bin Code	Spec. Range
	X2	800-900 mcd
	Y1	900-1000 mcd
\A/la :4 a	Y2	1000-1125 mcd
White	<b>Z</b> 1	1125-1270 mcd
	Z2	1270-1440 mcd
	AA1	1440-1610 mcd

# **Color Bin Grade Table**

(I<sub>F</sub> @ 20mA, T<sub>a</sub> 25 °C)

	Rank A0			
х	0.280	0.264	0.283	0.296
У	0.248	0.267	0.305	0.276

	Rank B3				
X	0.287 0.283 0.304 0.30				
У	0.295	0.305	0.330	0.315	

	Rank B4			
х	0.307	0.304	0.330	0.330
У	0.315	0.330	0.360	0.339

		Rank B5			
x	0.296	0.311			
У	0.276	0.295	0.315	0.294	

	Rank B6				
x	0.311 0.307 0.330 0.33				
у	0.294	0.315	0.339	0.318	

	Rank C0				
x	0.330 0.330 0.361 0.35				
у	0.318	0.360	0.385	0.351	

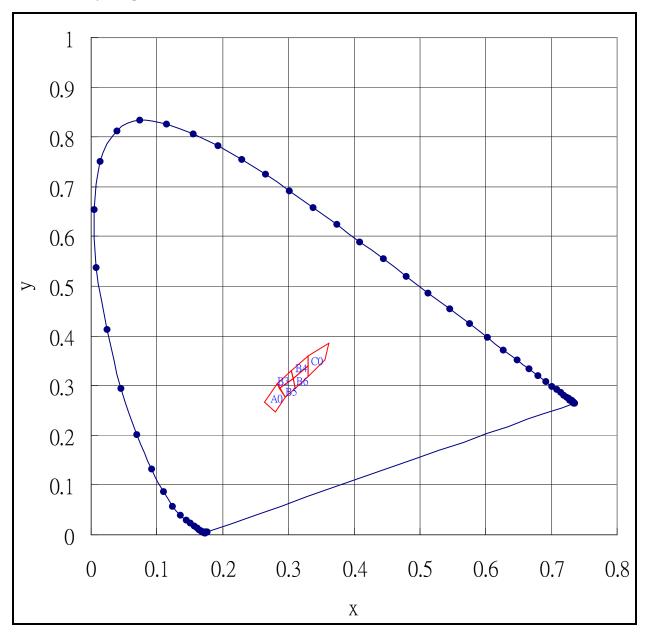
# ■ Vf Bin:

Color	Bin Code	Spec. Range
	G8	2.7-2.9V
	H7	2.9-3.1V
Blue	Н8	3.1-3.3V
	J7	3.3-3.5V
	J8	3.5-3.7V

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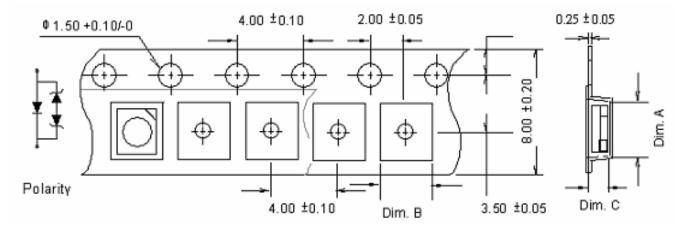
# **Chromaticity diagram**



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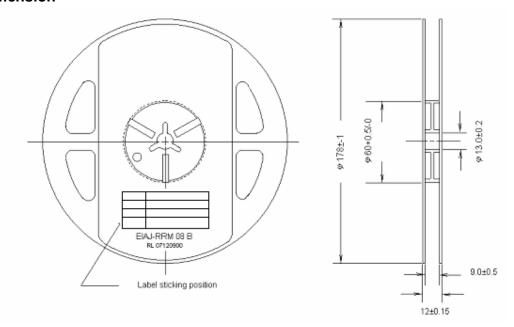
# Packaging Tape, Reel, and Packing Model Tape Dimension



Part No.	Dim. A	Dim. B	Dim. C	Q'ty/Reel
HT-U169	3.73±0.10	2.95±0.10	2.12±0.10	2K

Unit: mm

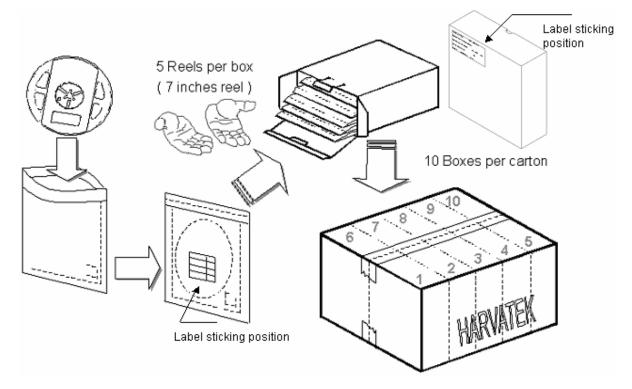
## **Reel Dimension**



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# **Packing Model**



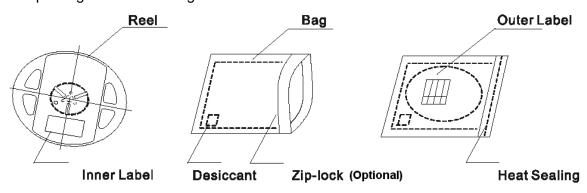
5 boxes per carton is available according to shipping quantity.

### **Dry Pack**

Any SMD optical device, like this chip LED, is **MOISTURE SENSITIVE device**. Avoid absorbing moisture at any time during transportation or storage. Every reel will be packaged in the moisture barrier anti-static bag (Specific bag material will depend upon customers' requirement or option). And the bag is well sealed before shipment.

By customer's requirement, we will put a humidity indicator in each moisture barrier anti-static bag before shipment.

The package is the following:



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#### **Cautions of Pick and Place**

It should be avoided to load stress on the resin during high temperature.

Avoid rubbing or scraping the resin by any object.

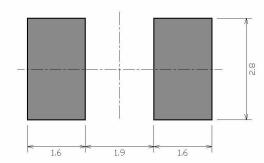
Electric-static may cause damage to the component. Please confirm that the equipment grounding well. Using an ionizer fan is recommended.

### **PRECAUTIONS**

- 1. Avoid absorbing moisture at any time during transportation or storage.
- 2. Anti-Static process is needed especially when handling GaN, InGaN, and AllnGaP products.
- 3. It is suggested to connect the unit with a proper series current limit resistor. Avoid driving reverse voltage over the specification of LEDs when turning the unit ON/OFF.
- 4. Any application should refer to the specifications of absolute maximum ratings.
- 5. Avoid any direct contact with the viewing area.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

### Soldering pattern

The dimensions of the recommended soldering pattern may not meet every user. Please confirm and study first before designing the soldering pattern in order to obtain the best performance of soldering. Recommended soldering pattern is listed below.



Unit: mm

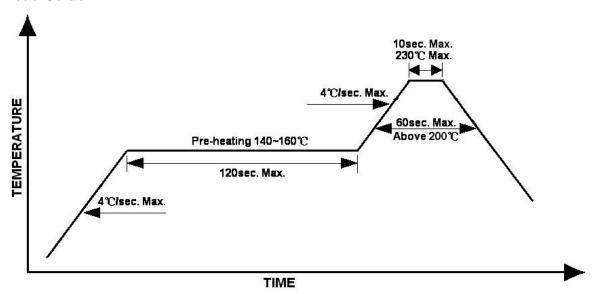
Soldering terminal may shift in x, y direction.

### **Re-flow Soldering**

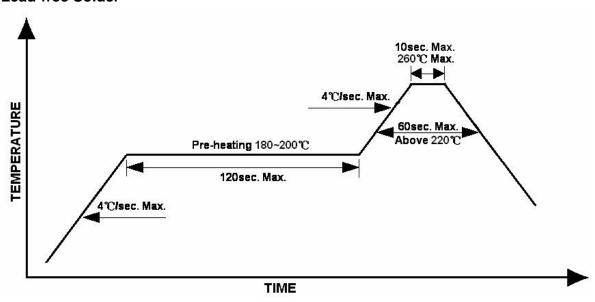
- Recommend tin glue specifications:
   Melting temperature: 178~192 °C
- ♦ Never take next process until the component is cooled down to room temperature after re-flow.
- The recommended re-flow soldering profile (measuring on the surface of the LED resin) is following:

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### **Lead Solder**



### **Lead-free Solder**



### Rework

- Customer must finish rework within 5 sec. under 260 °C.
- ♦ The head of iron cannot touch copper foil.
- Twin-head type is preferred.

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# Cleaning

The conditions of cleaning after soldering:

An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.

Temperature×Time: <50 °C×30sec, or <30 °C×3min

Ultra sonic cleaning: < 15W/ bath; Bath volume: 1liter max.

Curing: 100 °C max, <3min

Do not contact with component on the assembly board.

### **Cautions of Pick and Place**

It should be avoided to load stress on the resin during high temperature.

Avoid rubbing or scraping the resin by any object.

Electric-static may cause damage to the component. Please confirm that the equipment grounding well. Using an ionizer fan is recommended.

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